Power Transistors

Panasonic

2SB1179, 2SB1179A

Silicon PNP epitaxial planar type darlington

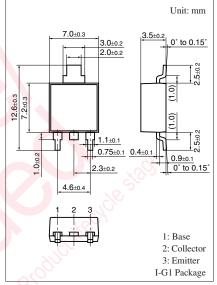
For power amplification and switching Complementary to 2SD1749, 2SD1749A

Features

- \bullet High forward current transfer ratio $h_{F\!E}$ which has satisfactory linearity
- High-speed switching
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment

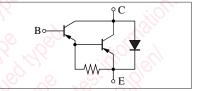
Parameter	Symbol	Rating	Unit					
Collector-base voltage	2SB1179	V _{CBO}	-60	V				
(Emitter open)	2SB1179A		-80					
Collector-emitter voltage	2SB1179	V _{CEO}	-60	V				
(Base open)	2SB1179A		-80					
Emitter-base voltage (Collector open)		V _{EBO}	-5	V				
Collector current		I _C	-4	А				
Peak collector current		I _{CP}	-8	А				
Collector power dissipation		P _C	15	W				
	$T_a = 25^{\circ}C$		1.3					
Junction temperature		Tj	150	°C				
Storage temperature		T _{stg}	-55 to +150	°C				
				IT XC				

Absolute Maximum Ratings $T_C = 25^{\circ}C$



Note) Self-supported type package is also prepared.

Internal Connection



Electrical Characteristics $T_c = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB1179	V _{CEO}	$I_{\rm C} = -30 \text{ mA}, I_{\rm B} = 0$	-60	011		V
(Base open)	2SB1179A	dil.	On U. YON Willing	-80	5		
Base-emitter voltage	. 2	V _{BE}	$V_{CE} = -3 V, I_C = -3 A$	00		-2.5	V
Collector-base cutoff	2SB1179	I _{CBO}	$V_{CB} = -60 \text{ V}, I_E = 0$	1.,		-200	μΑ
current (Emitter open)	2SB1179A		$V_{CB} = -80 \text{ V}, I_E = 0$			-200	
Collector-emitter cutoff	2SB1179	I _{CEO}	$V_{CE} = -40 \text{ V}, I_B = 0$			-500	μΑ
current (Base open)	2SB1179A		$V_{CE} = -40 \text{ V}, I_B = 0$			-500	
Emitter-base cutoff current (Col	lector open)	I _{EBO}	$V_{\rm EB} = -5 \text{ V}, I_{\rm C} = 0$			-2	mA
Forward current transfer ratio		h _{FE1}	$V_{CE} = -3 V, I_C = -0.5 A$	1 0 0 0			_
		h _{FE2} *	$V_{CE} = -3 V, I_C = -3 A$	2 0 0 0		10 000	
Collector-emitter saturation voltage		V _{CE(sat)}	$I_{\rm C} = -3$ A, $I_{\rm B} = -12$ mA			-2	V
			$I_{\rm C} = -5 \text{ A}, I_{\rm B} = -20 \text{ mA}$			-4	
Transition frequency		f _T	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time		t _{on}	$I_{C} = -3$ A, $I_{B1} = -12$ mA, $I_{B2} = 12$ mA		0.3		μs
Storage time		t _{stg}	$V_{CC} = -50 \text{ V}$		2.0		μs
Fall time		t _f			0.5		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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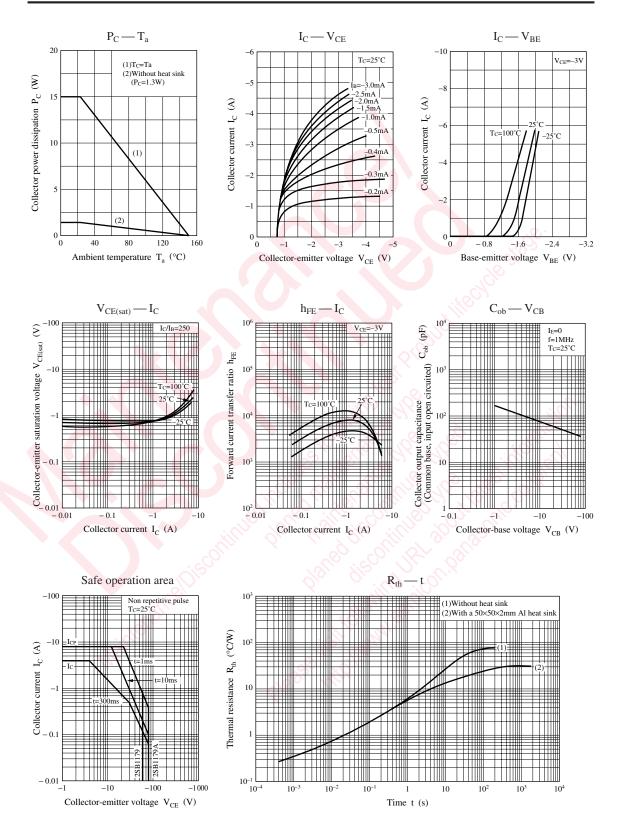
2. *: Rank classification

h_{FE2} 2 000 to 5 000 4 000 to 10 000

Q

Rank

Panasonic



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